

### Analog Peripherals

#### 10-Bit ADC

- Programmable throughput up to 200 kspS
- Up to 16 external inputs; programmable as single-ended or differential
- Reference from internal V<sub>REF</sub>, V<sub>DD</sub>, or external pin
- Internal or external start of conversion sources
- Built-in temperature sensor ( $\pm 3^{\circ}\text{C}$ )

#### Comparator

- Programmable hysteresis and response time
- Configurable to generate interrupts or reset
- Low current (0.4  $\mu\text{A}$ )

#### On-Chip Debug

- On-chip debug circuitry facilitates full speed, non-intrusive in-system debug (no emulator required)
- Provides breakpoints, single stepping, watchpoints
- Inspect/modify memory, registers, and stack
- Superior performance to emulation systems using ICE-chips, target pods, and sockets

#### Supply Voltage: 2.7 to 3.6 V

- Typical operating current: 6.4 mA at 25 MHz  
9  $\mu\text{A}$  at 32 kHz
- Typical stop mode current: <0.1  $\mu\text{A}$

#### Temperature Range: -40 to +85 °C

### High-Speed 8051 µC Core

- Pipelined instruction architecture; executes 70% of instructions in 1 or 2 system clocks
- Up to 25 MIPS throughput with 25 MHz clock
- Expanded interrupt handler

### Memory

- 768 bytes data RAM
- 4 kB Flash; in-system programmable in 512 byte sectors (512 bytes are reserved)

### Digital Peripherals

- 17 port I/O; all are 5 V tolerant
- Hardware SMBus™ (I2C™ compatible), SPI™, and UART serial ports available concurrently
- Programmable 16-bit counter/timer array with three capture/compare modules, WDT
- 4 general-purpose 16-bit counter/timers
- Real-time clock mode using PCA or timer and external clock source

### Clock Sources

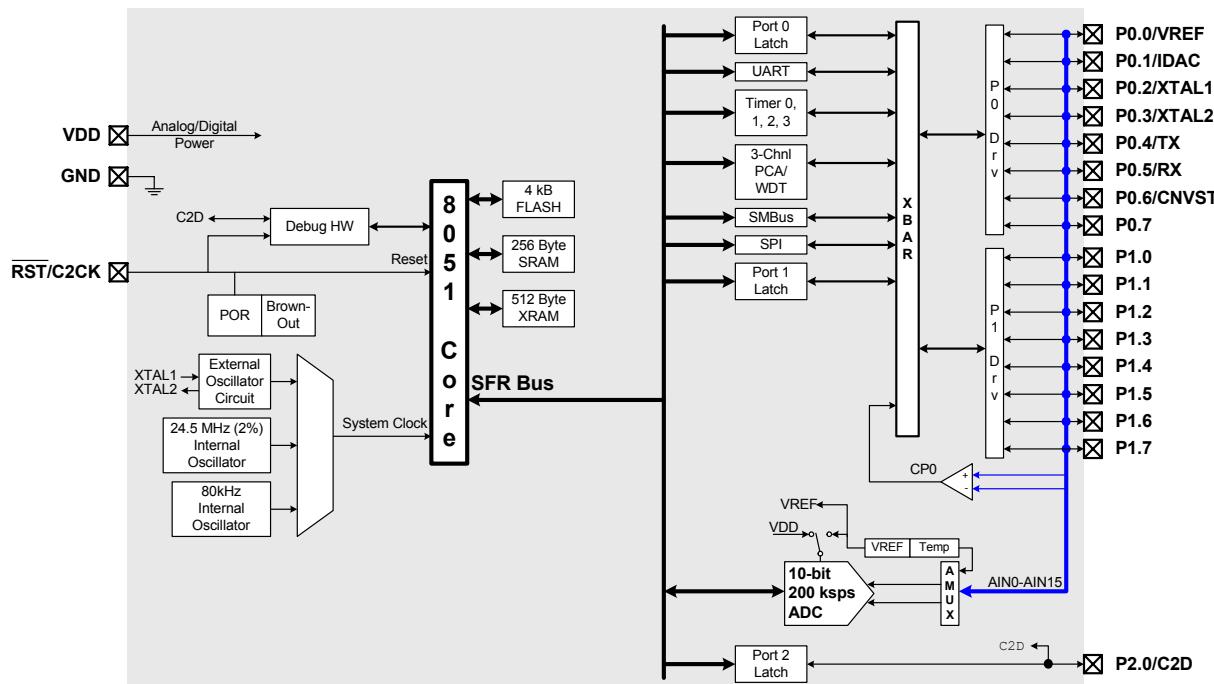
- Two internal oscillators:
  - 24.5 MHz, 2% accuracy supports UART operation
  - 80 kHz low frequency, low-power
- External oscillator: Crystal, RC, C, or Clock (1 or 2 pin modes)
- Can switch between clock sources on-the-fly

### Package

- 20-Pin QFN (lead-free package)

### Ordering Part Numbers

- C8051F332-GM



### Selected Electrical Specifications

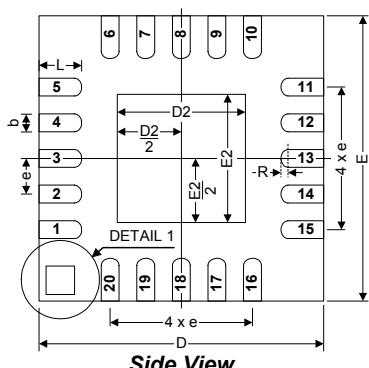
( $T_A = -40$  to  $+85^\circ\text{C}$ ,  $V_{DD} = 2.7$  V unless otherwise specified)

Parameter	Conditions	Min	Typ	Max	Units
<b>Global Characteristics</b>					
Supply Voltage		2.7		3.6	V
Supply Current with CPU active	Clock = 25 MHz Clock = 1 MHz Clock = 80 kHz; $V_{DD}$ Monitor Disabled Clock = 32 kHz; $V_{DD}$ Monitor Disabled	— — — —	6.4 0.36 20 9	— — — —	mA mA μA μA
Supply Current (shutdown)	Oscillator off; $V_{DD}$ Monitor Disabled	—	<0.1	—	μA
Clock Frequency Range		DC	—	25	MHz
<b>Internal Oscillators</b>					
Frequency (OSC0)		24.0	24.5	25.0	MHz
Frequency (OSC1)	See Note	—	80	—	kHz
<b>A/D Converter</b>					
Resolution			10		bits
Integral Nonlinearity		—	±1/2	±1	LSB
Differential Nonlinearity	Guaranteed Monotonic	—	±1/2	±1	LSB
Signal-to-Noise Plus Distortion		53	55.5	—	dB
Throughput Rate		—	—	200	kspS
Input Voltage Range		0	—	$V_{REF}$	V
<b>Comparator</b>					
Response Time Mode0	$(CP+) - (CP-) = 100$ mV	—	0.1	—	μs
Current Consumption Mode0		—	7.6	—	μA
Response Time Mode1	$(CP+) - (CP-) = 100$ mV	—	0.18	—	μs
Current Consumption Mode1		—	3.2	—	μA
Response Time Mode2	$(CP+) - (CP-) = 100$ mV	—	0.32	—	μs
Current Consumption Mode2		—	1.3	—	μA
Response Time Mode3	$(CP+) - (CP-) = 100$ mV	—	1	—	μs
Current Consumption Mode3		—	0.4	—	μA

**Note:** OSC1 can be calibrated in 2.5% steps using an internal calibration register.

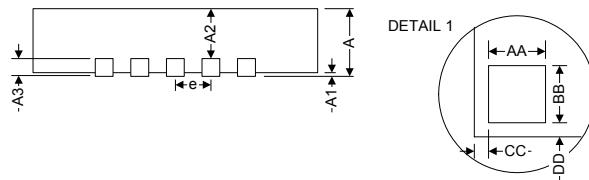
### Package Information

**Bottom View**

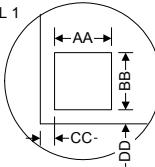


MM		
MIN	TYP	MAX
A	0.80	0.90
A1	0	0.02
A2	0	0.65
A3	0.25	
b	0.18	0.23
D	4.00	
D2	2.00	2.15
E	4.00	
E2	2.00	2.15
e	0.5	
L	0.45	0.55
N	20	
ND	5	
NE	5	
R	0.09	
AA	0.435	
BB	0.435	
CC	0.18	
DD	0.18	

**Side View**



DETAIL 1



### C8051F330DK Development Kit

